

Features

- $BV_{CEO} > 45V$
- Small Form Factor Thermally Efficient Package. Enables Higher Density End Products
- $I_C = 3A$ High Continuous Current
- High Gain $h_{FE} > 400 @ 1A$
- Low Saturation Voltage $V_{CE(SAT)} < 300mV @ 1A$
- Rated to $+175^\circ C$ —Ideal for High Temperature Environment
- Wettable Flank for Improved Optical Inspection
- **Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)**
- Halogen and Antimony Free. "Green" Device (Note 3)

Mechanical Data

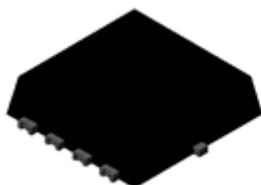
- Case: PowerDI® 3333-8
- Case Material: Molded Plastic. "Green" Molding Compound. UL Flammability Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish - Matte Tin Solderable per MIL-STD-202, Method 208③
- Weight: 0.03 grams (Approximate)

Applications

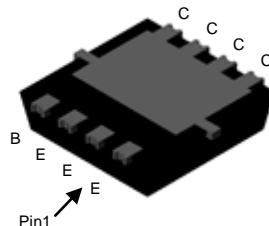
- Load Switch
- Linear Regulator
- MOSFET or IGBT Gate Driving

PowerDI3333-8 (SWP) (Type UX)

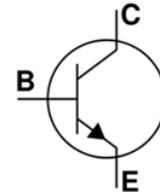
Equivalent Circuit



Top View



Bottom View



Device Symbol

Ordering Information (Note 4)

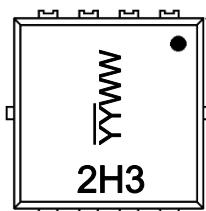
Part Number	Marking	Reel Size (inches)	Tape Width (mm)	Quantity per Reel
DXTN07045DFG-7	2H3	7	12	2000

Notes:

1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
2. See <https://www.diodes.com/quality/lead-free/> for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
4. For packaging details, go to our website at <https://www.diodes.com/design/support/packaging/diodes-packaging/>.

Marking Information

PowerDI3333-8 (SWP) (Type UX)



2H3 = Product Type Marking Code

YYWW = Date Code Marking

YY = Last Two Digits of Year (ex: 18 = 2018)

WW = Week Code (01 to 53)

Absolute Maximum Ratings (@ $T_A = +25^\circ\text{C}$, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Collector-Base Voltage	V_{CBO}	45	V
Collector-Emitter Voltage	V_{CEO}	45	V
Emitter-Base Voltage	V_{EBO}	7	V
Continuous Collector Current	I_C	3	A
Peak Pulse Current	I_{CM}	6	A

Thermal Characteristics (@ $T_A = +25^\circ\text{C}$, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Power Dissipation	P_D	0.9	W
		2.1	W
		3.1	W
Thermal Resistance, Junction to Ambient	$R_{\theta JA}$	140	°C/W
		65	°C/W
		44	°C/W
Thermal Resistance, Junction to Leads (Note 8)	$R_{\theta JL}$	8.5	°C/W
Operating and Storage Temperature Range	T_J, T_{STG}	-55 to +175	°C

ESD Ratings (Note 9)

Characteristic	Symbol	Value	Unit	JEDEC Class
Electrostatic Discharge—Human Body Model	ESD HBM	4000	V	3A
Electrostatic Discharge—Machine Model	ESD MM	400	V	C

Notes:

- 5. For a device mounted with the collector tab on MRP FR4-PCB; device is measured under still air conditions whilst operating in a steady-state.

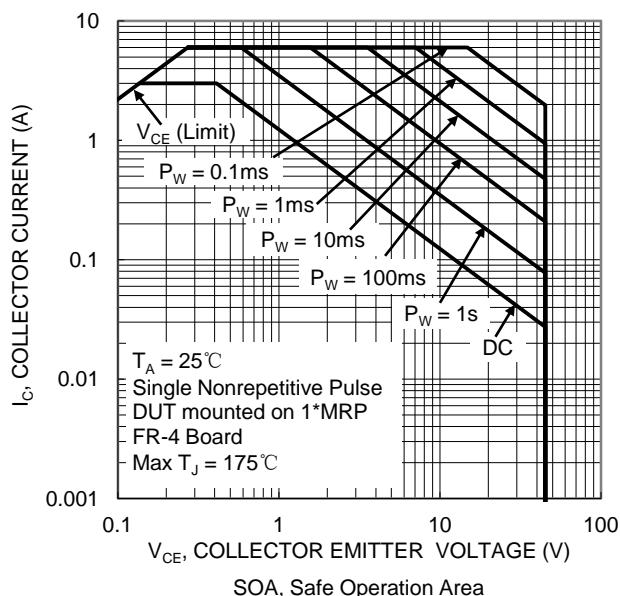
- 6. Same as Note 5, except the device is mounted on 25mm × 25mm 2oz copper.

- 7. Same as Note 5, except the device is mounted on 50mm × 50mm 2oz copper.

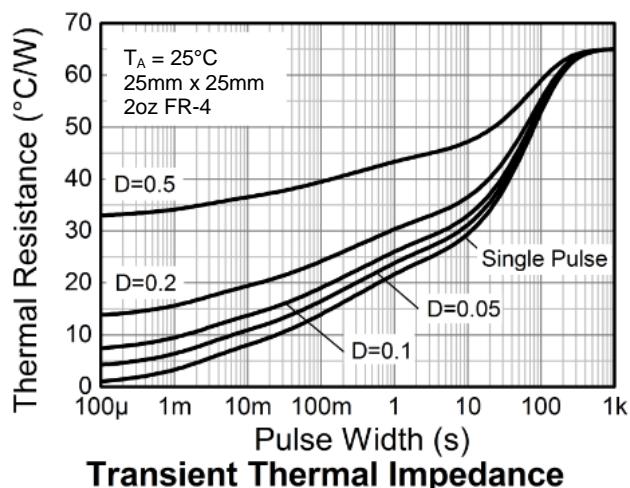
- 8. Thermal resistance from junction to solder-point (at the collector tab).

- 9. Refer to JEDEC specification JESD22-A114 and JESD22-A115.

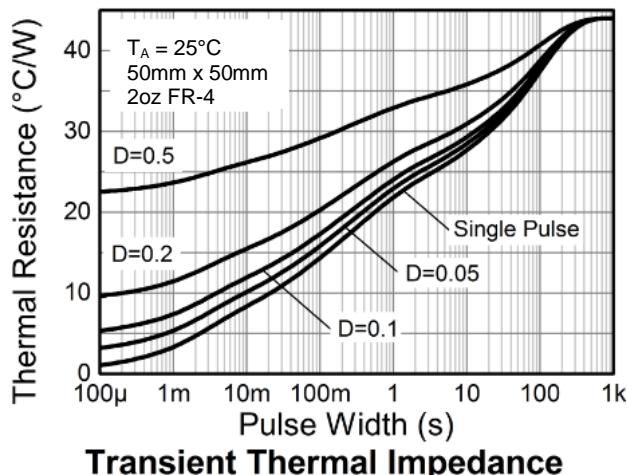
Thermal Characteristics and Derating Information



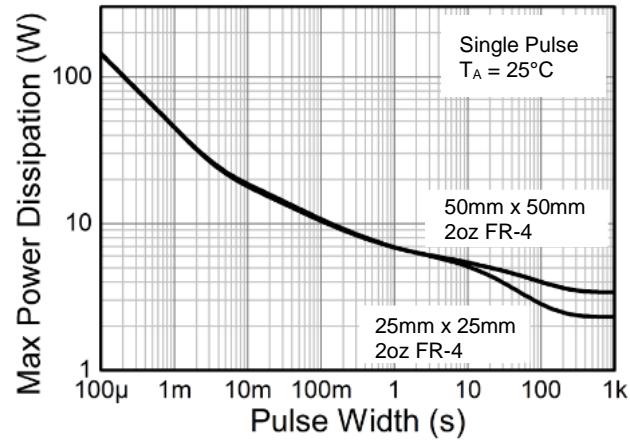
SOA, Safe Operation Area



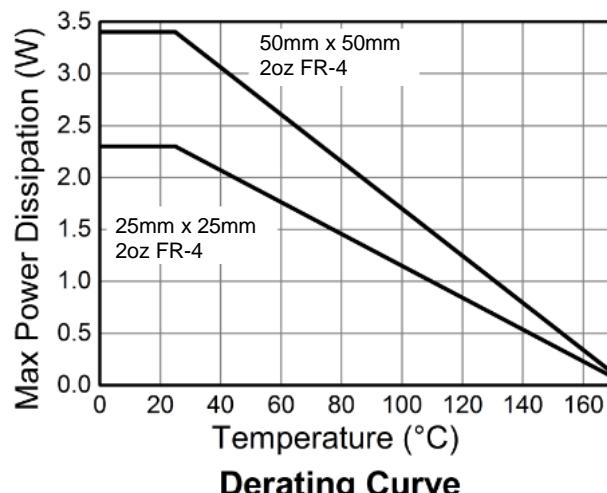
Transient Thermal Impedance



Transient Thermal Impedance



Pulse Power Dissipation



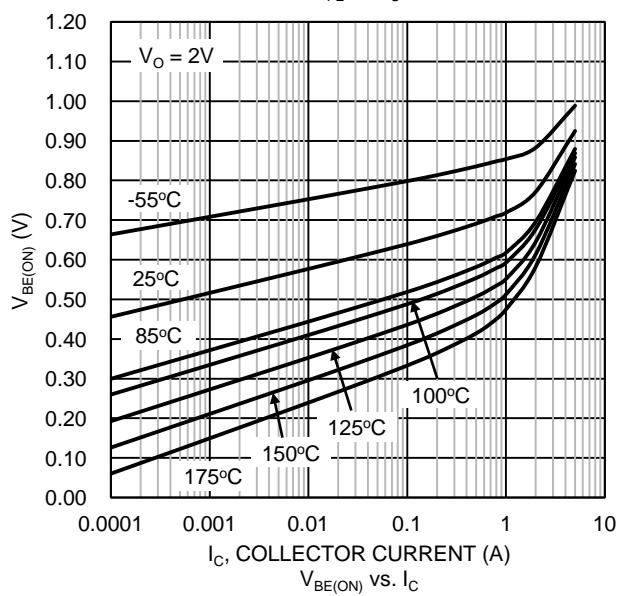
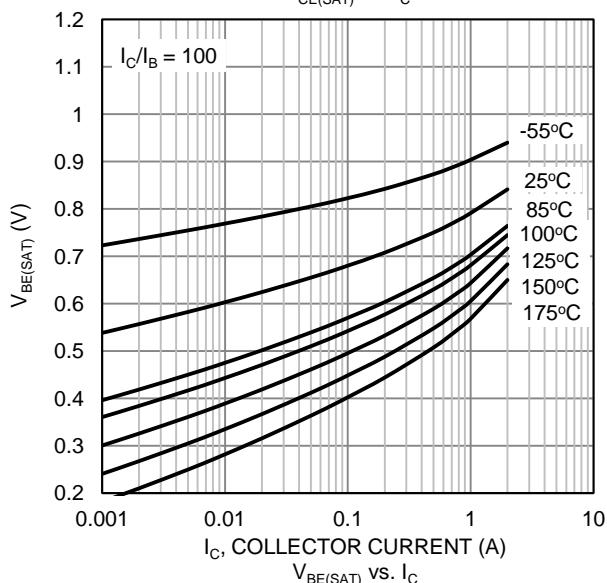
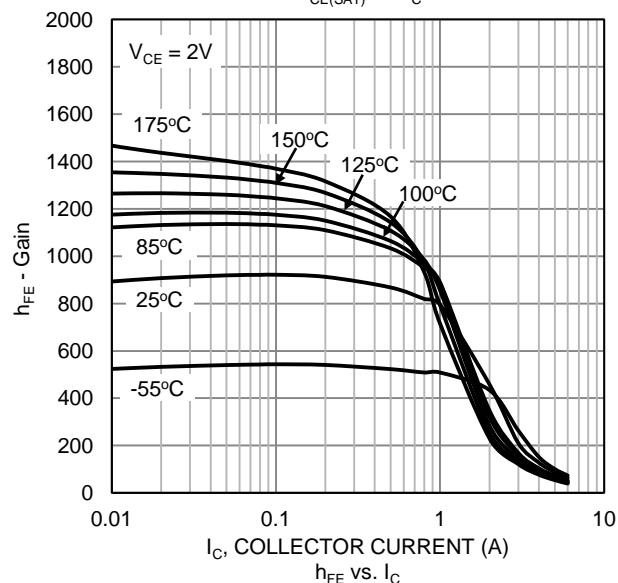
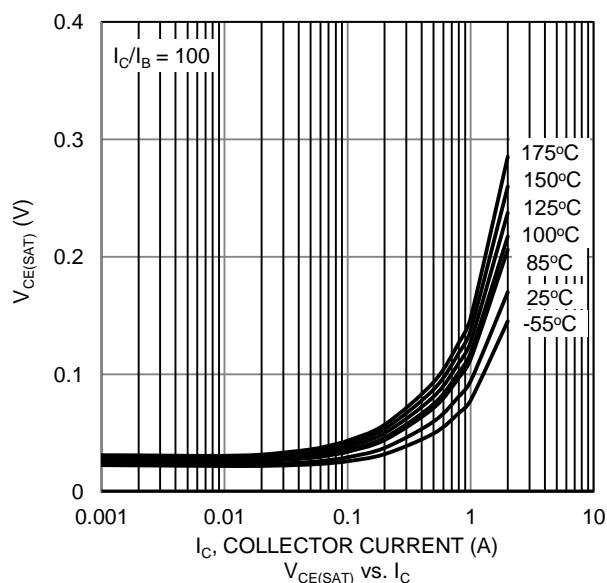
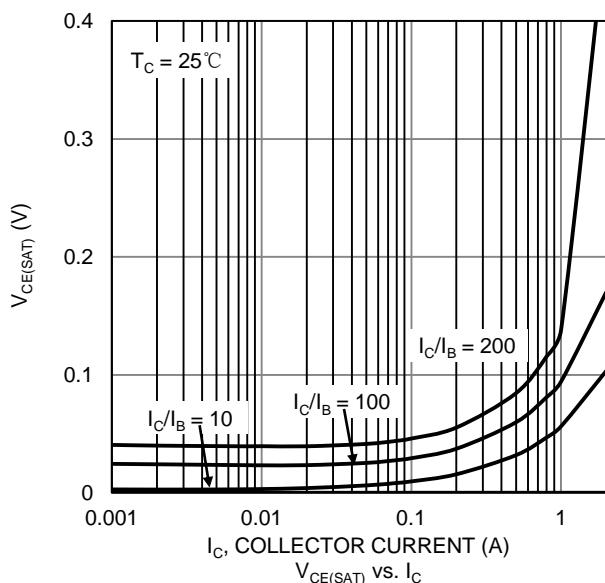
Derating Curve

Electrical Characteristics (@ $T_A = +25^\circ\text{C}$, unless otherwise specified.)

Characteristic	Symbol	Min	Typ	Max	Unit	Test Condition
Collector-Base Breakdown Voltage	BV_{CBO}	50	143	—	V	$I_C = 100\mu\text{A}$
Collector-Emitter Breakdown Voltage (Note 10)	BV_{CEO}	45	58	—	V	$I_C = 10\text{mA}$
Emitter-Base Breakdown Voltage	BV_{EBO}	7	8.3	—	V	$I_E = 100\mu\text{A}$
Collector-Base Cut-Off Current	I_{CBO}	—	—	20	nA	$V_{\text{CB}} = 45\text{V}$
		—	—	10	μA	$V_{\text{CB}} = 45\text{V}, T_A = +125^\circ\text{C}$
Emitter Cut-Off Current	I_{EBO}	—	—	20	nA	$V_{\text{EB}} = 6\text{V}$
DC Current Gain (Note 10)	h_{FE}	500	—	—	—	$I_C = 0.1\text{A}, V_{\text{CE}} = 2\text{V}$
		400	780	—	—	$I_C = 1\text{A}, V_{\text{CE}} = 2\text{V}$
		150	470	—	—	$I_C = 2\text{A}, V_{\text{CE}} = 2\text{V}$
		50	223	—	—	$I_C = 3\text{A}, V_{\text{CE}} = 2\text{V}$
Collector-Emitter Saturation Voltage (Note 10)	$\text{V}_{\text{CE}(\text{SAT})}$	—	46	100	mV	$I_C = 0.1\text{A}, I_B = 0.5\text{mA}$
		—	140	300	mV	$I_C = 1\text{A}, I_B = 5\text{mA}$
Base-Emitter Saturation Voltage (Note 10)	$\text{V}_{\text{BE}(\text{SAT})}$	—	0.79	1	V	$I_C = 1\text{A}, I_B = 10\text{mA}$
Base-Emitter Turn-On Voltage (Note 10)	$\text{V}_{\text{BE}(\text{ON})}$	—	0.73	0.9	V	$I_C = 1\text{A}, V_{\text{CE}} = 2\text{V}$
Input Capacitance	C_{IBO}	—	200	—	pF	$V_{\text{EB}} = 0.5\text{V}, f = 1\text{MHz}$
Output Capacitance	C_{COBO}	—	16	—	pF	$V_{\text{CB}} = 10\text{V}, f = 1\text{MHz}$
Current Gain-Bandwidth Product	f_T	150	—	—	MHz	$V_{\text{CE}} = 5\text{V}, I_C = 50\text{mA}, f = 50\text{MHz}$
Turn-On Time	t_{ON}	—	33	—	ns	$V_{\text{CC}} = 10\text{V}, I_C = 500\text{mA}$ $I_{B1} = -I_{B2} = 50\text{mA}$
Turn-Off Time	t_{OFF}	—	1,300	—	ns	

Note: 10. Measured under pulsed conditions. Pulse width $\leq 300\mu\text{s}$. Duty cycle $\leq 2\%$.

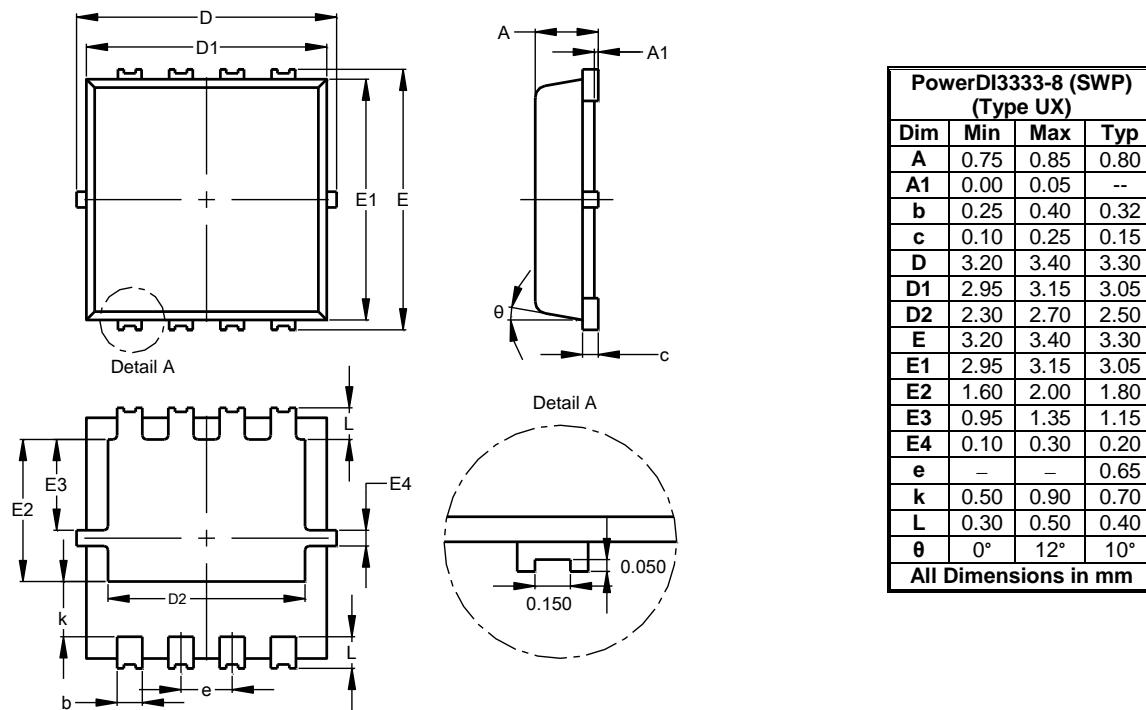
Typical Electrical Characteristics (@ $T_A = +25^\circ\text{C}$, unless otherwise specified.)



Package Outline Dimensions

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

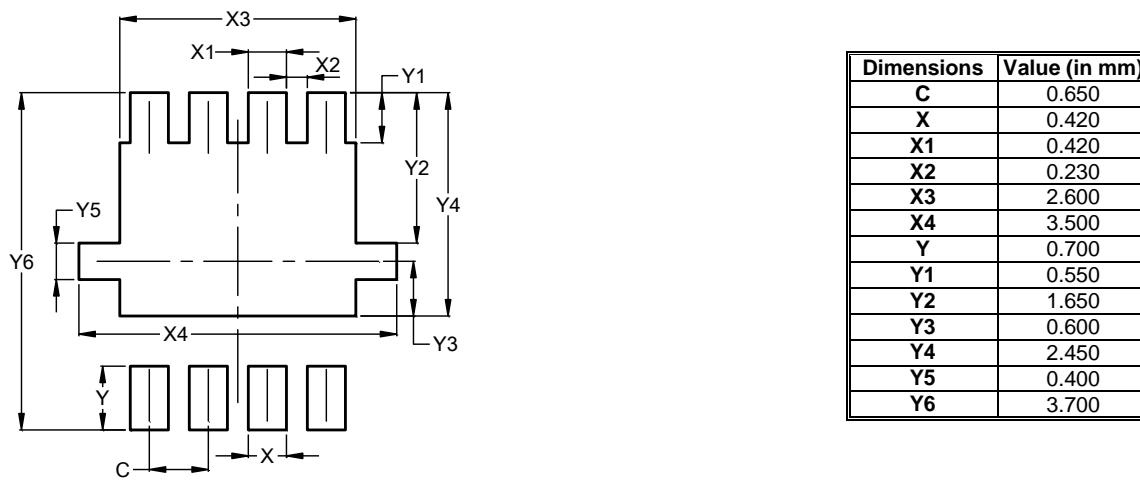
PowerDI3333-8 (SWP) (Type UX)



Suggested Pad Layout

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

PowerDI3333-8 (SWP) (Type UX)



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